

16-bit Cascadable ALU (Extended Set)

FEATURES

- ☐ High-Speed (15ns), Low Power 16-bit Cascadable ALU
- ☐ Extended Function Set (32 Advanced ALU Functions)
- ☐ All Registers Have a Bypass Path for Complete Flexibility
- ☐ Replaces IDT7383
- ☐ Available 100% Screened to MIL-STD-883, Class B
- ☐ Package Styles Available:
- 68-pin Plastic LCC, J-Lead
 - 68-pin Ceramic LCC
 - 68-pin Ceramic PGA

DESCRIPTION

The L4C383 is a flexible, high speed, cascadable 16-bit Arithmetic and Logic Unit. The L4C383 is capable of performing up to 32 different arithmetic or logic functions.

The L4C383 can be cascaded to perform 32-bit or greater operations. See "Cascading the L4C383" on the next page.

ARCHITECTURE

The L4C383 operates on two 16-bit operands (A and B) and produces a 16-

bit result (F). Five select lines control the ALU and provide 19 arithmetic and 13 logical functions. Registers are provided on both the ALU inputs and the output, but these may be bypassed under user control. An internal feedback path allows the registered ALU output to be routed to one or both of the ALU inputs, accommodating chain operations and accumulation.

L4C383

ALU OPERATIONS

The S4–S0 lines specify the operation to be performed. The ALU functions and their select codes are shown in Table 1.

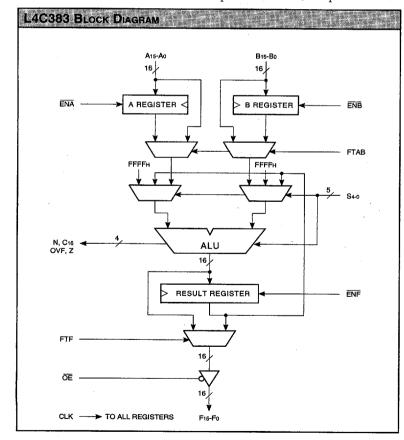
ALU STATUS

The ALU provides Overflow and Zero status bits. A Carry output is also provided for cascading multiple devices, however it is only defined for the 19 arithmetic functions. The ALU sets the Zero output when all 16 output bits are zero. The N, C16 and OVF flags for the arithmetic operations are defined in Table 2.

OPERAND REGISTERS

The L4C383 has two 16-bit wide input registers for operands A and B. These registers are rising edge triggered by a common clock. The A register is enabled for input by setting the ENA control LOW, and the B register is enabled for input by setting the ENB control LOW. When either the ENA control or ENB control is HIGH, the data in the corresponding input register will not change.

This architecture allows the L4C383 to accept arguments from a single 16-bit data bus. For those applications that do not require registered inputs, both the A and B operand registers can be bypassed with the FTAB control line.



--- Arithmetic Logic Units

02/06/97-LDS.383-A

5565905 0003931 487



16-bit Cascadable ALU (Extended Set)

TABLE 1	
	. ALU FUNCTIONS FUNCTION
\$4-\$0	A + B + Co
00000	
00001	A OR B
00010	A + B + C0
00011	A + B + Co
00100	A + Co
00101	A OR F
00110	A – 1 + C0
00111	A + Co
01000	A + F + C0
01001	A OR F
01010	A + F + Co
01011	Ā + F + Co
01100	F + B + Co
01101	ĀORB
01110	F + B + C0
01111	F + B + Co
10000	A XOR B
10001	A AND B
10010	Ā AND B
10011	A XNOR B
10100	A XOR F
10101	A AND F
10110	Ā AND F
10111	ALL 1's + Co
11000	B + Co
11001	A AND B
11010	B̄ + Co
11011	B-1+C0
11100	F + Co
11101	A OR B
11110	F – 1 + C0
11111	F + C0

When the FTAB control is asserted (FTAB = HIGH), data is routed around the A and B input registers; however, they continue to function normally via the ENA and ENB controls. The contents of the input registers will again be available to the ALU if the FTAB control is released.

TABLE 2. ALU STATUS FLAGS	
Bit Carry Generate = gi = AiBi	for i = 0 15
Bit Carry Propagate = pi = Ai + Bi	for i = 0 15
Po = po	
$P_{i} = p_{i}(P_{i-1})$	for i = 1 15
and	
Go = go	
Gi = gi + pi (Gi–1)	for i = 1 15
$C_i = G_{i-1} + P_{i-1} (C_0)$	for i = 1 15
then	
C16 = G15 + P15C0	
OVF = C15 XOR C16	
Zero = All Output Bits Equal Zero	
N = Sign Bit of ALU Operation	

OUTPUT REGISTER

The output of the ALU drives the input of a 16-bit register. This rising-edgetriggered register is clocked by the same clock as the input registers. When the ENF control is LOW, data from the ALU will be clocked into the output register. By disabling the output register, intermediate results can be held while loading new input operands. Three-state drivers controlled by the $\overline{\text{OE}}$ input allow the L4C383 to be configured in a single bidirectional bus system.

The output register can be bypassed by asserting the FTF control signal (FTF = HIGH). When the FTF control is asserted, output data is routed around the output register, however, it continues to function normally via the ENF control. The contents of the output register will again be available on the output pins if FTF is released.

CASCADING THE L4C383

Cascading the L4C383 to 32 bits is accomplished simply by connecting the C16 output of the least significant slice to the C0 input of the most significant slice. The S4-S0, ENA, ENB, and ENF lines are

common to both devices. The Zero output flags should be logically ANDed to produce the Zero flag for the 32-bit result. The OVF and C16 outputs of the most significant slice are valid for the 32-bit result.

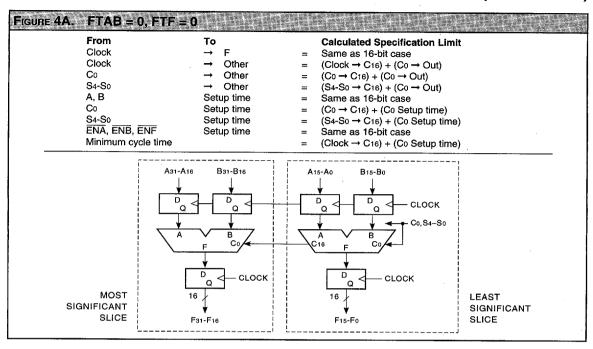
Propagation delay calculations for this configuration require two steps: First determine the propagation delay from the input of interest to the C16 output of the lower slice. Add this number to the delay from the C0 input of the upper slice to the output of interest (of the C0 setup time, if the F register is used). The sum gives the overall input-to-output delay (or setup time) for the 32-bit configuration. This method gives a conservative result, since the C16 output is very lightly loaded. Formulas for calculation of all critical delays for a 32-bit system are shown in Figures 4A through 4D.

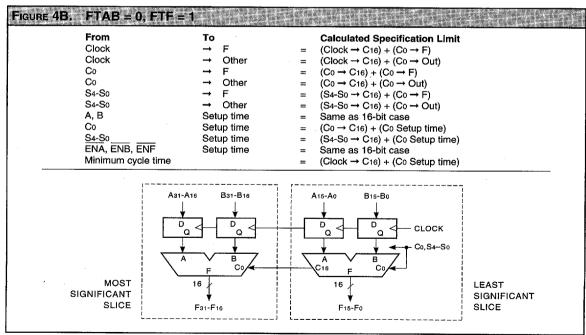
Cascading to greater than 32 bits can be accomplished by simply connecting the C16 output of each slice to the C0 input of the next more significant slice. Propagation delays are calculated as for the 32-bit case, except that the C0 to C16 delays for all intermediate slices must be added to the overall delay for each path.

■ 5565905 0003932 313 ■ ____ Arithmetic Logic Units



16-bit Cascadable ALU (Extended Set)





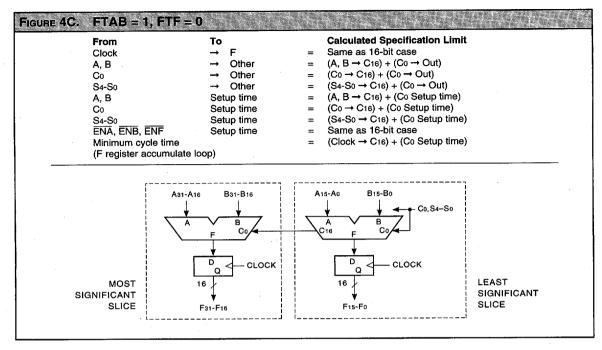
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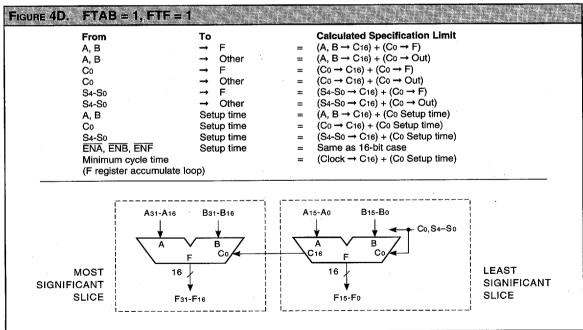
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02/06/97-LDS.383-A



16-bit Cascadable ALU (Extended Set)





■ 5565905 0003934 196 ■ ____ Arithmetic Logic Units



16-bit Cascadable ALU (Extended Set)

Storage temperature	65°C to +150°C
Operating ambient temperature	55°C to +125°C
VCC supply voltage with respect to ground	0.5 V to +7.0 V
nput signal with respect to ground	3.0 V to +7.0 V
Signal applied to high impedance output	3.0 V to +7.0 V
Output current into low outputs	25 mA
Latchup current	

OPERATING CONDITIONS To meet specified electrical and switching characteristics

Mode

Temperature Range (Ambient)

Supply Voltage

Active Operation, Commercial Active Operation, Military

0°C to +70°C

 $4.75 \text{ V} \le \text{V} \text{CC} \le 5.25 \text{ V}$

-55°C to +125°C 4.50 V ≤ **V**CC ≤ 5.50 V

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V OH	Output High Voltage	Vcc = Min., IoH = -2.0 mA	2.4	.,,,,	linux	V
V OL	Output Low Voltage	VCC = Min., IOL = 8.0 mA			0.5	V
V iH	Input High Voltage		2.0		V cc	٧
V iL	Input Low Voltage	(Note 3)	0.0		0.8	٧
lıx	Input Current	Ground ≤ VIN ≤ VCC (Note 12)			±20	μА
loz	Output Leakage Current	Ground ≤ Vout ≤ Vcc (Note 12)			±20	μΑ
ICC1	Vcc Current, Dynamic	(Notes 5, 6)		15	30	mA
ICC2	Vcc Current, Quiescent	(Note 7)			1.5	mA

5565905 0003935 022 **Arithmetic Logic Units**



16-bit Cascadable ALU (Extended Set)

SWITCHING CHARACTERISTICS — COMMERCIAL OPERATING RANGE (0°C to +70°C)

GUARANTEED MAXIMUM C	OMBINAT	TONAL	DELAYS	Note	9, 10 (n	(s)						
To Output		L4C3	83-55			L4C3	83-40			L4C3	83-26	
From Input	F15-F0	N	OVF, Z	C16	F15-F0	N	OVF, Z	C 16	F15-F0	N	OVF, Z	C16
FTAB = 0, FTF = 0												
Clock	32	38	53	36	26	30	44	32	22	22	26	22
Co	—	_	34	22		_	28	20	_	_	18	18
S4-S0	—	42	42	42		32	34	35		22	22	22
FTAB = 0, FTF = 1												
Clock	56	38	53	36	46	30	44	32	28	22	26	22
Co	37		34	22	30	_	28	20	22		18	18
S4-S0	55	42	42	42	40	32	34	35	26	22	22	22
FTAB = 1, FTF = 0												
A15-A0, B15-B0		36	46	37	_	30	40	32		22	22	22
Clock	32	_		_	26		_	_	22			
Co	l —	_	34	22		_	28	20	_	_	18	18
S4-S0		42	42	42	<u> </u>	32	34	35		22	22	22
FTAB = 1, FTF = 1												
A15-A0, B15-B0	55	36	46	37	40	30	· 40	32	26	22	22	22
Clock	56	38	53	36	46	30	44	32	28	22	26	22
Co	37		34	22	30	_	28	20	22	_	18	18
S4-S0	55	42	42	42	40	32	34	35	26	22	22	22

GUARANTEED MINIMUL	M SETUP AN	в Ноц	o Times	With	RESPEC	т то С	LOCK R	ising E	DGE N	otes 9,	10 (ns)	
		L4C3	83-55			L4C3	83-40			L4C3	83-26	
·	FTA	3 = 0	FTAE	3 = 1	FTA	3 = 0	FTAE	3 = 1	FTAE	3 = 0	FTAE	3 = 1
Input	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold
A15-A0, B15-B0	8	2	35	2	8	2	28	2	8	2	16	2
Co	21	0	21	0	16	0	16	0	8	0	8	0
S4-S0	44	0	44	0	32	0	32	0	18	0	18	0
ENA, ENB, ENF	10	2	10	2	10	2	10	2	8	2	8	2

TRI-STAT	e Enable/Disabi	ETIMES Notes	9, 10, 11 (ns)
	L4C383-55	L4C383-40	L4C383-26
t ENA	20	18	16
tois	20	18	16

CLOCK CYCLE TIN	IE AND PULSE	WIDTH Notes	9, 10 (ns)
	L4C383-55	L4C383-40	L4C383-26
Minimum Cycle Time	43	34	20
Highgoing Pulse	15	10	10
Lowgoing Pulse	15	10	10

■ 5565905 0003936 T69 ■ ——Arithmetic Logic Units



16-bit Cascadable ALU (Extended Set)

SWITCHING CHARACTERISTICS — COMMERCIAL OPERATING BANGE (0°C to +70°C)

GUARANTEED MAXIMUM (COMBINAT	TIONAL	DELAYS	Note	s 9, 10 (r	15)			
To Output		L4C3	83-20			L4C3	83-15		·
From Input	F15-F0	N	OVF, Z	C16	F15-F0	N	OVF, Z	C ₁₆	
FTAB = 0, FTF = 0									
Clock	11	20	20	20	11	15	15	15	
Co	_	_	14	14		_	13	13	
S4-S0		18	20	18	_	14	15	14	
FTAB = 0, FTF = 1									
Clock	20	20	20	20	15	15	15	15	·
Co	18		14	14	14	_	13	13	
S4-S0	20	18	20	18	15	14	15	14	
FTAB = 1, FTF = 0									-
A15-A0, B15-B0	_	16	20	17	_	14	15	14	
Clock	11	_	_	_	11			_	
Co	_	_	14	14	_	_	13	13	
S4-S0	_	18	20	18	_	14	15	14	
FTAB = 1, FTF = 1									
A15-A0, B15-B0	20	16	20	17	15	14	15	14	
Clock	20	20	20	20	15	15	15	15	
Co	18		14	14	14	_	13	13	
S4-S0	20	18	20	18	15	14	15	14	

•		L4C3	83-20			L4C3	83-15			
	FTAE	3 = 0	FTAE	3 = 1	FTAE	3 = 0	FTAE	3 = 1		
Input	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold		
A15-A0, B15-B0	5	0	14	0	5	0	12	0		
Co	12	0	12	0	10	0	10	0		
S4-S0	15	0	15	0	12	0	12	0		
ENA, ENB, ENF	5	0	5	0	5	0	5	0	Ì	

TRI-STATE	ENABLE/DISABI	E TIMES Notes	9, 10, 11 (ns)
	L4C383-20	L4C383-15	
t ENA	8	6	
tois	8	6	

CLOCK CYCLE TIN	E AND PULSE	WIDTH Notes	9, 10 (ns)
	L4C383-20	L4C383-15	-
Minimum Cycle Time	18	14	
Highgoing Pulse	5	4	
Lowgoing Pulse	5	4	

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16-bit Cascadable ALU (Extended Set)

SWITCHING CHARACTERISTICS — MILITARY OPERATING RANGE (-55°C to +125°C)

GUARANTEED MAXIMUM C	OMBINAT	IONAL	DELAYS	Note	s 9, 10 (n	ıs)						
To Output		L4C3	83-65			L4C3	83-45			L4C3	83-30	
From Input	F15-F0	N	OVF, Z	C16	F15-F0	N	OVF, Z	C16	F15-F0	N	OVF, Z	C 16
FTAB = 0, FTF = 0												
Clock	37	44	63	45	28	34	50	34	26	28	34	28
Co	_	_	42	25		—	32	23	_		22	22
S4-S0	-	48	48	48		38	38	38	_	28	28	28
FTAB = 0, FTF = 1								-				
Clock	68	44	63	45	56	34	50	34	34	28	34	28
Co	42		42	25	32		32	23	26	_	22	22
S4-S0	66	48	48	48	46	38	38	38	- 30	28	28	28
FTAB = 1, FTF = 0												
A15-A0, B15-B0	_	44	56	44		32	46	36	—	28	28	28
Clock	. 37		_	_	28	_	_	_	26	_	_	_
Co	_	_	42	25			32	23			22	22
S4-S0	_	48	48	48		38	38	38		28	28	28
FTAB = 1, FTF = 1												
A15-A0, B15-B0	65	44	56	44	45	32	46	36	30	28	28	28
Clock	68	44	63	45	56	34	50	34	34	28	34	28
Co	42	_	42	25	32	—	32	23	26		22	22
S4-S0	66	48	48	48	46	38	38	38	30	28	28	28

		L4C383-65				L4C3	83-45		L4C383-30			
	FTAE	3 = 0	FTAE	3 = 1	FTAE	3 = 0	FTAE	3 = 1	FTAE	3 = 0	FTAE	3 = 1
Input	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold
A15-A0, B15-B0	10	3	43	3	8	3	33	3	8	3	20	3
Co ·	25	0	25	0	20	0	20	0	12	0	12	0
S4-S0	50	0	50	0	36	0	36	0	20	0	20	0
ENA, ENB, ENF	12	2	12	2	10	2	10	2	10	2	10	2

TRI-STATE ENABLE/DISABLE TIMES Notes 9, 10, 11 (ns)								
	L4C383-65	L4C383-45	L4C383-30					
t ENA	22	20	18					
tDIS	22	20	18					

CLOCK CYCLE TIN	IE AND PULSE	WIDTH Notes 9, 10 (ns)				
	L4C383-65	L4C383-45	L4C383-30			
Minimum Cycle Time	52	38	26			
Highgoing Pulse	20	15	12			
Lowgoing Pulse	20	15	12			

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16-bit Cascadable ALU (Extended Set)

SWITCHING CHARACTERISTICS — MILITARY OPERATING RANGE (-55°C to +125°C)

GUARANTEED MAXIMUM C	COMBINAT	IONAL	DELAYS	Note:	s 9, 10 (r	ıs)			
To Output		L4C3	883-25			L4C3	83-20		
From Input	F15-F0	N	OVF, Z	C 16	F15-F0	N	OVF, Z	C16	
FTAB = 0, FTF = 0									
Clock	14	24	24	24	14	20	20	20	
Co			18	18	_	_	16	16	
S4-S0	_	22	24	22	_	18	20	18	
FTAB = 0, FTF = 1							•		
Clock	25	24	24	24	20	20	20	20	•
Co	21	_	18	18	17	_	16	16	
S4-S0	25	22	24	22	20	18	20	18	¥
FTAB = 1, FTF = 0									
A15-A0, B15-B0	—	20	25	22	_	17	20	17	
Clock	14	_	_	_	14		_		
Co		_	18	18		. —	16	16	
S4-S0		22	24	22		18	20	18	
FTAB = 1, FTF = 1		•		-			•		
A15-A0, B15-B0	25	20	25	22	20	17	20	17	
Clock	25	24	24	24	20	20	20	20	
Co	21	_	18	18	17	_	16	16	
S4-S0	25	22	24	22	20	18	20	18	

		L4C3	83-25		L4C383-20					
	FTAE	3 = 0	FTAE	3 = 1	FTAE	3 = 0	FTAE	3 = 1		
Input	Setup	Hold	Setup	Hold	Setup	Hold	Setup	Hold		
A15-A0, B15-B0	7	2	14	2	6	2	12	2		
Co	14	0	14	0	12	0	12	0		
S4-S0	19	o	19	0	16	0	16	0		
ENA, ENB, ENF	7	0	7	0	6	0	6	0		

Tri-State Enable/Disable Times Notes 9, 10, 11 (ns)								
	L4C383-25	L4C383-20						
t ENA	14	10						
tDIS	14	10						

CLOCK CYCLE TIME AND PULSE WIDTH Notes 9, 10 (ns)									
	L4C383-25	L4C383-20							
Minimum Cycle Time	20	18							
Highgoing Pulse	8	6							
Lowgoing Pulse	8	6							

5565905 0003939 778 Arithmetic Logic Units

02/06/97-LDS.383-A

16-bit Cascadable ALU (Extended Set)

NOTES

- 1. Maximum Ratings indicate stress specifications only. Functional operation of these products at values beyond those indicated in the Operating Conditions table is not implied. Exposure to maximum rating conditions for extended periods may affect reliability.
- 2. The products described by this specification include internal circuitry designed to protect the chip from damaging substrate injection currents and accumulations of static charge. Nevertheless, conventional precautions should be observed during storage, handling, and use of these circuits in order to avoid exposure to excessive electrical stress values.
- 3. This device provides hard clamping of transient undershoot and overshoot. Input levels below ground or above VCC will be clamped beginning at –0.6 V and VCC + 0.6 V. The device can withstand indefinite operation with inputs in the range of –0.5 V to +7.0 V. Device operation will not be adversely affected, however, input current levels will be well in excess of 100 mA.
- 4. Actual test conditions may vary from those designated but operation is guaranteed as specified.
- Supply current for a given application can be accurately approximated by:

NCV²F

where

N = total number of device outputs

C = capacitive load per output

V = supply voltage

F = clock frequency

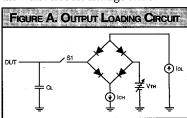
- 6. Tested with all outputs changing every cycle and no load, at a 5 MHz clock rate.
- 7. Tested with all inputs within 0.1 V of VCC or Ground, no load.
- 8. These parameters are guaranteed but not 100% tested.

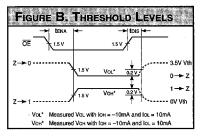
9. AC specifications are tested with input transition times less than 3 ns, output reference levels of 1.5 V (except tDIS test), and input levels of nominally 0 to 3.0 V. Output loading may be a resistive divider which provides for specified IOH and IOL at an output voltage of VOH min and VOL max respectively. Alternatively, a diode bridge with upper and lower current sources of IOH and IOL respectively, and a balancing voltage of 1.5 V may be used. Parasitic capacitance is 30 pF minimum, and may be distributed.

This device has high-speed outputs capable of large instantaneous current pulses and fast turn-on/turn-off times. As a result, care must be exercised in the testing of this device. The following measures are recommended:

- a. A 0.1 μ F ceramic capacitor should be installed between **V**CC and Ground leads as close to the Device Under Test (DUT) as possible. Similar capacitors should be installed between device **V**CC and the tester common, and device ground and tester common.
- b. Ground and VCC supply planes must be brought directly to the DUT socket or contactor fingers.
- c. Input voltages should be adjusted to compensate for inductive ground and VCC noise to maintain required DUT input levels relative to the DUT ground pin.
- 10. Each parameter is shown as a minimum or maximum value. Input requirements are specified from the point of view of the external system driving the chip. Setup time, for example, is specified as a minimum since the external system must supply at least that much time to meet the worst-case requirements of all parts. Responses from the internal circuitry are specified from the point of view of the device. Output delay, for example, is specified as a maximum since worst-case operation of any device always provides data within that time.

- 11. For the tena test, the transition is measured to the 1.5 V crossing point with datasheet loads. For the tDIS test, the transition is measured to the ±200mV level from the measured steady-state output voltage with ±10mA loads. The balancing voltage, VTH, is set at 3.5 V for Z-to-0 and 0-to-Z tests, and set at 0 V for Z-to-1 and 1-to-Z tests.
- These parameters are only tested at the high temperature extreme, which is the worst case for leakage current.



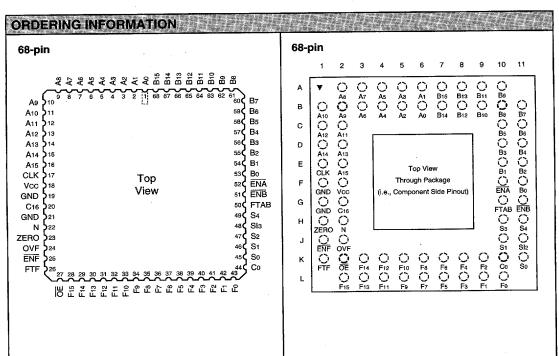


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Arithmetic Logic Units



16-bit Cascadable ALU (Extended Set)



Speed	Plastic J-Lead Chip Carrier (J2)	Ceramic Leadless Chip Carrier (K3)	Ceramic Pin Grid Array (G1)
	0°C to +70°C — Commercial	SCREENING	为并在"对于"。"对于"并且这个"所有的"的。在10°
55 ns	L4C383JC55		L4C383GC55
40 ns	L4C383JC40		L4C383GC40
26 ns	L4C383JC26		L4C383GC26
20 ns	L4C383JC20		L4C383GC20
1.5 ns	L4C383JC15		L4C383GC15
	-55°C to +125°C COMME	RCIAL SCREENING	
65 ns			L4C383GM65
45 ns			L4C383GM45
30 ns			L4C383GM30
25 ns			L4C383GM25
20 ns			L4C383GM20
op. I	-55°C to +125°C MIL-S1	D-883 COMPLIANT	
65 ns		L4C383KMB65	L4C383GMB65
45 ns		L4C383KMB45	L4C383GMB45
30 ns		L4C383KMB30	L4C383GMB30
25 ns		L4C383KMB25	L4C383GMB25
20 ns		L4C383KMB20	L4C383GMB20

5565905 0003941 326 **Arithmetic Logic Units**

02/06/97-LDS.383-A